



Product Specification

TUDI-MAX491

Low-Power, Slew-Rate-Limited RS-485/RS-422 Transceivers

网址 www.sztdbdt.com Q

用芯智造・卓越品质

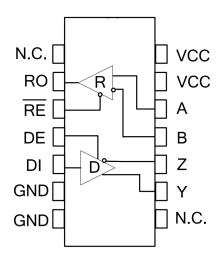
semiconductor device manufacturer

- Design
- research and development
- production
- and sales



Features

- 4.5V~5.5V power supply, RS485/RS422 full-duplex communication;
- •ail-Safe function;
- 1/8 unit load, allowing up to 256 devices to be connected to the bus;
- Short-circuit output for the driver;
- Receiver open-circuit fail-safe protection;
- Strong anti-noise capability;
- Integrated transient voltage suppression function;
- Data rate in an electrical noise environment can reach 2.5Mbps;
- A, B port protection: HBM±15KV;



Pin diagram

Description

The MAX491 is a low-power transceiver for RS-422 communication. Each device contains a driver and a receiver. The 491 driver has an unrestricted conversion rate, allowing them to transmit up to 2.5Mbps.

These transceivers consume supply current between 10µA and 500µA, when idle or fully loaded with the driver disabled. All devices operate from a single 5V supply. The drivers have shortcircuit current limiting and are protected by a thermal shutdown circuit that places the driver output into a high-impedance state to prevent excessive power dissipation. The receiver inputs have a-safe feature that guarantees the output to be logic high if the input is open. The MAX491 has a receiver input impedance of one-eighth unit load, allowing maximum of 256 transceivers to be connected to a bus. The MAX491 is full duplex communication.

Applications

- ■Low-Power RS-485/RS-422 Transceivers
- ■Level TranslatorsTransceivers for EMI-Sensitive Applications
- Industrial-Control Local Area Networks



Pin description

Pin number	Pin name	Pin function
1	NC	No internal connections required
2	RO	Receiver output.When RE is low,the RO output is high if A-B is -10mV,and low if A-B is -200mV.
3	/RE	Receiver output enable control.When/RE is low,the receiver output is enabled and RO is active;when/REis high,the receiver output is disabled and RO is in high-impedance state.When RE is at a high level and DE is at a low level,the device enters low-power shutdown mode
4	DE	The driver output enables the control. When DE is at high level, the driver outputs effectively; when DE is low, it outputs high-impedance state. When RE is high and DE is low, the device enters low-power shutdown mode.
5	DI	DI driver input.When DE is high, the low level on DI makes the in-phase output A of the driver low and the in-phase output B high; the high levelon DI makes the in-phase output high and the in-phase output Blow.
6	GND	Landing
7	GND	Landing
8	NC	No internal connections required
9	Υ	Driver in-phase output terminal
10	Z	Driver inverting output
11	В	Receiver inverting input
12	А	Receiver in phase input
13	VCC	This pin can be connected to power or left unconnec-ted
14	VCC	Power connection



Extreme parameter

Parameter	Symbol	Unit	size
Continuous nower consumption	SOP14	mW	600
Continuous power consumption	DIP14	mW	700
Power supply voltage	VCC	V	+7
working temperature range			-40~125
Storage temperature range		- \	-60~150
Welding temperature range			300
Control port voltage	DI	- v	-0.3~VCC+0.3
Bus side input voltage	A, B	V	-8~13
Receiver output voltage	RO	V	-0.3~VCC+0.3

The maximum limit parameters are values beyond which the device can be damaged in an irreversible manner. Operation of the device under these conditions is not intended to be normal and may affect the reliability of the device if operated continuously at the maximum rated limit. All voltages are referenced to ground.

ESD Protect								
Parameter	symbol	Test condition	Minimum	Typical case	Maximum	Unit		
A、B、Y、Z		Human bodymodel		±15		KV		
Other ports		Human bodymodel		±6		KV		



Receiver Switching Characteris-tics							
Parameter	symbol	Test condition	Minimum	Typical case	Maximum	Unit	
Acceptor	tRPLH	See Figure 7 and Figure 8	20	60	90	ns	
Input to output propag- ation delay from low to high							
The propagation delay from receiverinput to output is from high to low	tRPHL	V 2.0V;risingand falling edgetime ViD 15ns	20	60	90	ns	
tRPLH-tRPHLI	tsKEW2			7	10	ns	
Enable low time out	tRPZL	CL=15pF SeeFigures 7 and 8		20	50	ns	
Enable to output high time	tRPZH	CL=15pF SeeFigures 7 and 8	icon	20	50	ns	
Time from output low to disable	tpRLZ	CL=15pF SeeFigures 7 and 8	10011	20	45	ns	
Time from output high to disable	tpRHZ	CL=15pF SeeFigures 7 and 8		20	45	ns	
Off stateEnable to output high time	tRPSH	CL=15pF SeeFigures 7 and 8		200	1400	ns	
Off stateEnable low time out	tRPSL	CL=15pF SeeFigures 7 and 8		200	1400	ns	
Time to turn off	tsHDN	NOTE2	80		300	ns	

(If not otherwise, VCC=3V \sim 5.5V, Temp = TMIN \sim TMAX, typical value at Temp = 25) NOTE 1:? VO D and? VOC is the change in VOD and VOC amplitude caused when the DI state of the input signal changes, respectively.



	DC electrical characteristics of the driver							
Parameter	symbol	Test condition	Minimum	Typical case	Maximum	Unit		
Driver differential output (non-loaded)	VoD ₁			4.5	VCC	V		
Drive differential output	VoD ₂	graph 2,RL=27	1.5	2.3	VCC	V		
Drive differential output	VOD2	graph 2,RL=50	2	2.8	VCC	V		
Variation in the amplitude of the output voltage (NOTE1)	VoD	graph 2,RL=27			0.2	V		
Output common mode voltage	Voc	graph 2,RL=27	7 \]	/ E	3	V		
Amplitude Variation of Common Mode Output Voltage(NOTE1)	Voc	graph 2,RL=27			0.2	V		
High-level input	VH	DI DI	2.0	lauc	tol	V		
Low level input	V	DI			0.8	V		
Logic input current	IN1	DI	-2		2	uA		
Output the current during ashort circuit, with high short-circuit	losD ₁	Short circuit to OV~12V	35		250	mA		
Output the current during ashort circuit,down to low	losD ₂	Short circuit to- 7V~0V	-250		-35	mA		

(If not otherwise, VCC= $3V\sim5.5V$, Temp = TMIN \sim TMAX, typical value at Temp = 25) NOTE 1:? VO D and? VOC is the change in VOD and VOC amplitude caused when the DI state of the input signal changes, respectively.





	drive switch characteristics						
Parameter	symbol	Test condition	Minimum	Typical case	Maximum	Unit	
Input to output propagation delay (low to high)	tDPLH			12	35	ns	
Input to output propagation delay (high to low)	tDPHL	RDIFF=54 ,CL= CL?=100pF(see		12	35	ns	
tDPLH-tDPHLI	tsKEW1	Fi-gure 3 and Figure 4)		6	10	ns	
Rise time /fall time	tDR,tDF			9	25	ns	
Enable to high output	tpZH	R=110 (seeFigure 5 and 6)		20	90	ns	
Enable to output low	tpZL	-		20	90	ns	
Input low to disable	tpLZ	R=110 (seeFigure 5 and 6)		20	80	ns	
Enable high input	tpHZ	ıdi Sen	nicor	20	80	ns	
Enable high outputunder off condition	tDSH	R=110 (seeFigure 5 and 6)		500	900	ns	
Enable low outputunder shutdown conditions	tDSL	RL=110 (seeFigure 5 and 6)		500	900	ns	

Supply Current								
Parameter	symbol	Test condition	Minimum	Typicel case	Maximum	Unit		
	Iccl	/RE=0V,DE=0V		220	400	uA		
Supply current	lcc2	/RE=VCC, DE=VCC		240	400	uA		
Turn-off current	IsHDN	/RE=VCC,DE=0V		0.5	10	uA		



DC Electrical Characteristics of the Receiver

Parameter	symbol	Test condition	Minimum	Typical case	Maximum	Unit
Input ourront(A.D.)	IN2	VCC=0 or 3.3V VIn=12V			125	uA
Input current(A,B)	IIVZ	VCC=0 or 3.3V VIn=-7V	-100			uA
Forward input threshold voltage	VIT+	-7V Vcm 12V			-10	mV
Reverse input threshold voltage	VIT-	-7V Vcm 12V	-200			mV
Input hysteresis voltage	Vhys	-7V Vcm 12V	10	30	= '	mV
High level output voltage	VoH	IoUT=-4mA, VID=+200 mV	VCC-1.5	ndu	ctor	٧
Low level output voltage	VoL	IoUT=+4mA, VID=-200 mV			0.4	٧
Three state input leakage cur-rent	lozR	0.4V <vo<2.4v< td=""><td></td><td></td><td>±1</td><td>uA</td></vo<2.4v<>			±1	uA
Input resistance of receiver	RIN	-7V VcM 12V	96			k
Receiver short circuit curr-ent	IosR	0V Vo VCC	±7		±95	mA



Function table

Receiving function table						
con	control		output			
/RE	DE	A-B	RO			
0	Х	≥-10mV	Н			
0	х	≤-200mV	L			
0	Х	Open/short circuit	Н			
1	Х	Х	Z			

X: any level; Z: high impedance.

Send function table						
cont	rol	input	output			
/RE	DE	DI	Y	Z		
х	1	1	н	L		
х	1	0	L	н		
0	0	х	Z	Z		
1	0	Х	Z(shut	down)		

X: any level; Z: high impedance.

Additional description Tudi Semiconductor

Introduction

The 491 is a full-duplex high-speed transceiver for RS-485/RS-42 communication, containing a driver and a receiver. It has fail-safe, overvoltage protection, and overcurrent protection. The TUDI-MAX491 achieves error-free transmission up to 2.5 Mbps.

fail-safe

The 491 guarantees a logic high receiver output if the receiver input is short-circuited or open-circuited,or drivers connected to the terminated transmission line are disabled (idle). This is achieved by setting the receiver input thresholds to -10mV and -20mV, respectively. RO is logic high if the differential receiver input voltage(A-B)≥-10mV, and RO is logic low the voltage(A-B)≤-200mV. Logic high with a minimum noise margin of 50mV can be realized depending the receiver thresholds. The-10mV to -200mV threshold voltage is in accordance with the EIA/TIA-485 of±200mV.

256 transceivers on the bus

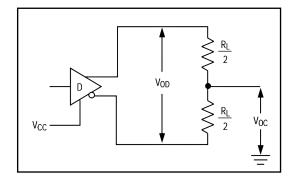
The input impedance of the standard RS485 receiver is 12k (1 unit load), and the standard driver can drive to 32 unit loads. The receiver of the 491 transceiver has an input impedance of 1/8 unit load (96k ,allowing up to 256 transceivers to be connected in parallel on the same communication bus. These devices can be combined arbitrarily, or combined with other 485 transceivers, as long as the total load does not exceed 256 unit loads, they can be connected to the same bus.

Drive output protection

Protection against excessive output current and dissipation by fault or bus contention is provided by overcurrent and overvoltage protection mechanisms, with fast short-circuit throughout the common-mode voltage range (see Typical Operating Characteristics).



Test circuit



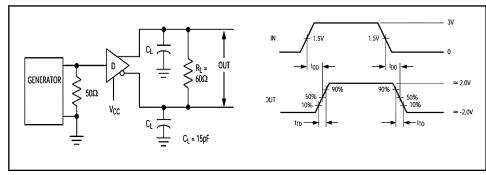


Figure 2: DC test load for the drive

Figure 3 Drive-line Differential Delay and Transit Time

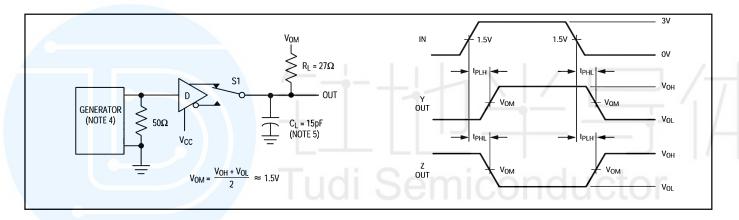


Figure 4 Drive propagation delay

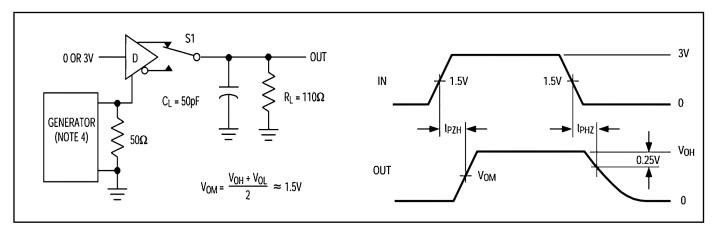


Figure 5 Drive enable and disable time



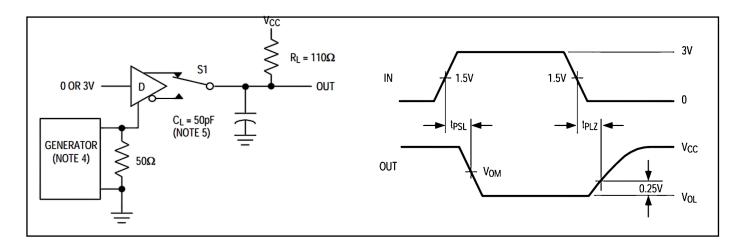


Figure 6 Drive enable and disable time

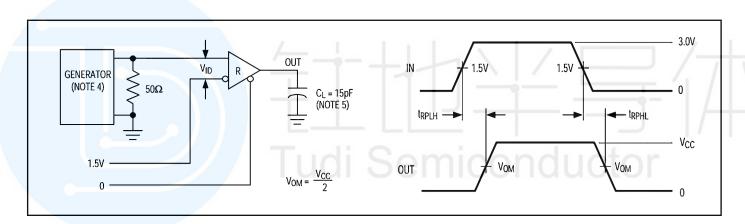
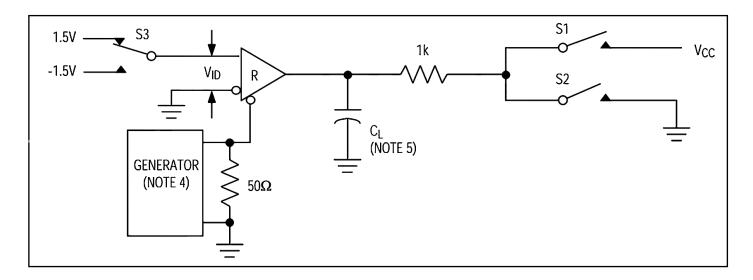


Figure 7: Receiver Propagation Delay Test Circuit





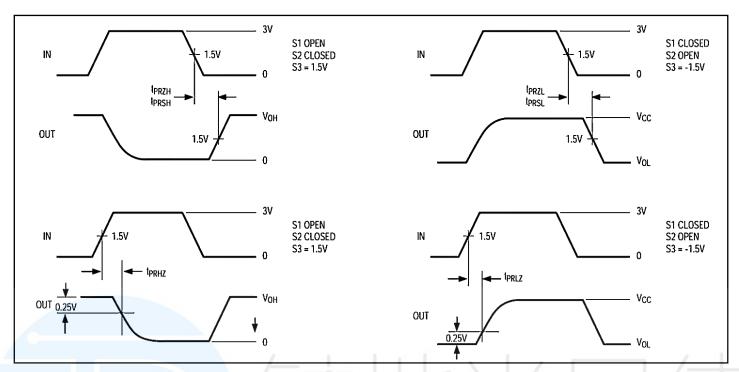


Figure 8 Receive enable and disable time

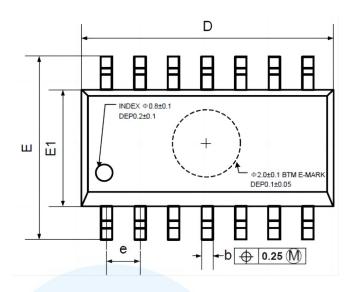
Order information

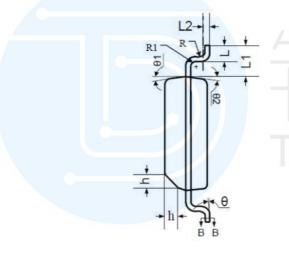
Order Number	Package	Package Quantity On The park		Temperature	
MAX491CPD-TUDI	DIP14	Tube,25,A box of 1000	MAX491CPD	0°C to 70°C	
MAX491CSD-TUDI	SOP14	Tape,Reel,2500	MAX491CSD	- 0°C to 70°C	
MAX491EPD-TUDI	DIP14	Tube,25,A box of 1000	MAX491EPD	- 40°C to 85°C	
MAX491ESD-TUDI	SOP14	Tape,Reel,2500	MAX491ESD	- 40 C 10 85 C	

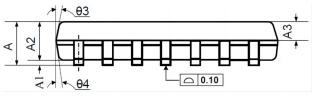


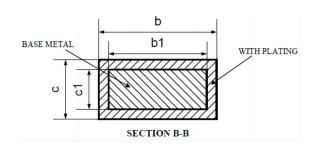


Package SOP14





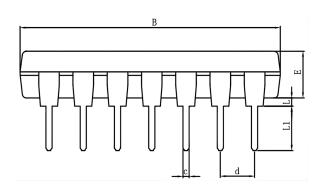


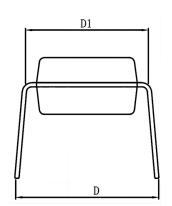


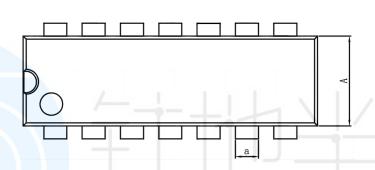
Symphol		Dimensio Millime	
Symbol	MIN	NOM	MAX
А	1.35	1.60	1.75
A1	0.10	0.15	0.25
A2	1.25	1.45	1.65
A3	0.55	0.65	0.75
b	0.36		0.49
b1	0.35	0.40	0.45
С	0.16		0.25
c1	0.15	0.20	0.25
D	8.53	8.63	8.73
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
е	du	1.27 BS0	9r
L	0.45	0.60	0.80
L1		1.04 REI	=
L2		0.25 BS0	2
R	0.07		
R1	0.07		
h	0.30	0.40	0.50
θ	0°		8°
θ1	6°	8°	10°
θ2	6°	8°	10°
θ3	5°	7°	9°
θ4	5°	7°	9°



Package DIP14







DIM.	MIN	ТҮР	MAX	DIM.	MIN	ТҮР	MAX
А	6.100	6.300	6.680	а	1.504	1.524	1.544
В	18.940	19.200	19.560	C	0.437	0.457	0.477
D	8.200	8.700	9.200	d	2.530	2.540	2.550
D1	7.42	7.62	7.82	L	0.500	_	0.800
Е	3.100	3.300	3.550	L1	3.000	3.200	3.600



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